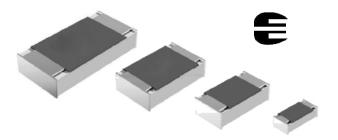
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Precision Thin Film Chip Resistors



Thin Film Flat Chip Resistors combine the proven reliability of the professional products with an advanced level of precision and stability. Therefore they are perfectly suited for applications in the fields of test and measuring equipment together with industrial and medical electronics.

FEATURES

- Approved according to EN 140401-801
- Low TCR: ± 10 ppm/K to ± 25 ppm/K
- Precision tolerance of value: ± 0.1 % and ± 0.25 % COMPLIANT
- Superior overall stability: Class 0.1 and 0.25
- Lead (Pb)-free solder contacts
- Compliant to RoHS directive 2002/95/EC

APPLICATIONS

- Automotive
- Test and measuring equipment
- Medical equipment
- Industrial equipment

METRIC SIZE								
INCH: 0402		0603	0805	1206				
METRIC:	RR 1005M	RR 1608M	RR 2012M	RR 3216M				

TECHNICAL SPECIFICA	LIONS							
DESCRIPTION	MCS	0402	MC	Г 0603	MCU 0805		MCA 1206	
Metric size	RR 1	005M	RR 1	608M	RR 2012M		RR 3216M	
Resistance range	100 Ω to	o 221 kΩ	39 Ω to	o 511 kΩ	39 Ω to	1.5 MΩ	39 Ω t	ο 2 ΜΩ
Resistance tolerance				± 0.25 %	%; ± 0.1 %			
Temperature coefficient			± 25	ppm/K; ± 15	ppm/K; ± 10	ppm/K		
Operation mode	Precision	Standard	Precision	Standard	Precision	Standard	Precision	Standard
Climatic category (LCT/UCT/days)	10/85/56	55/125/56	10/85/56	55/125/56	10/85/56	55/125/56	10/85/56	55/125/56
Rated dissipation, $P_{70}^{(1)}$	0.016 W	0.063 W	0.032 W	0.1 W	0.050 W	0.125 W	0.1 W	0.25 W
Operating voltage, Umax. AC/DC	12.5 V	50 V	25 V	75 V	35 V	150 V	50 V	200 V
Film temperature	85 °C	125 °C	85 °C	125 °C	85 °C	125 °C	85 °C	125 °C
Max. resistance change at P_{70} for resistance range, $\Delta R/R$ max., after:	100 Ω to 221 kΩ		39 Ω to 511 k Ω		39 Ω to 1.5 MΩ		39 Ω to 2 M Ω	
1000 h	≤0.1 %	≤ 0.2 %	≤0.1 %	≤ 0.2 %	≤ 0.1 %	≤ 0.2 %	≤ 0.05 %	≤ 0.1 %
8000 h	≤0.2 %	≤ 0.4 %	≤ 0.2 %	≤ 0.4 %	≤ 0.2 %	≤ 0.4 %	≤ 0.1 %	≤ 0.25 %
225 000 h	≤ 0.5 %	≤ 1.0 %	≤ 0.5 %	≤ 1.0 %	≤ 0.5 %	≤ 1.0 %	≤ 0.25 %	≤ 0.5 %
Specified lifetime	225	000 h	225	000 h	225 (000 h	225	000 h
Insulation voltage:								
1 min; <i>U</i> _{ins}	75 V		100 V		200 V		300 V	
Continuous	75	5 V	75 V		75 V		75 V	
Failure rate: FIT _{observed}	≤ 0.1 x	(10 ⁻⁹ /h	≤ 0.1 x	x 10 ⁻⁹ /h	≤ 0.1 x	10 ⁻⁹ /h	≤ 0.1 x 10 ⁻⁹ /h	

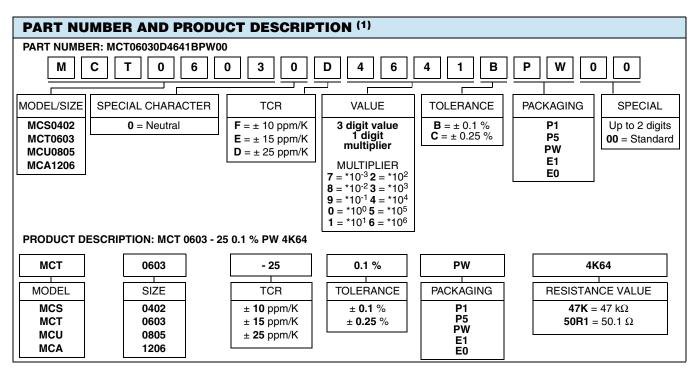
Note

⁽¹⁾ The power dissipation on the resistor generates a temperature rise against the local ambient, depending on the heat flow support of the printed-circuit board (thermal resistance). The rated dissipation applies only if the permitted film temperature is not exceeded.



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Note

⁽¹⁾ Products can be ordered using either the PRODUCT DESCRIPTION or the PART NUMBER

TEMPERATURE COEFFICIENT AND RESISTANCE RANGE								
DESCF	RIPTION		RESISTANC	E VALUE ⁽²⁾				
TCR	TOLERANCE	MCS 0402	MCT 0603	MCU 0805	MCA 1206			
. 05	± 0.25 %	100 Ω to 221 kΩ	39 Ω to 511 k Ω	39 Ω to 1.5 MΩ	39 Ω to 2 MΩ			
± 25 ppm/K	± 0.1 %	150 Ω to 221 kΩ	47 Ω to 511 kΩ	47 Ω to 1.5 M Ω	47 Ω to 2 MΩ			
15 ppm/K	± 0.25 %	100 Ω to 150 kΩ	39 Ω to 332 k Ω	39 Ω to 1 M Ω	39 Ω to 1.5 MΩ			
± 15 ppm/K	± 0.1 %	150 $Ω$ to 150 k $Ω$	47 Ω to 332 k Ω	47 Ω to 1 M Ω	47 Ω to 1.5 M Ω			
± 10 ppm/K ⁽³⁾	± 0.25 %	100 Ω to 130 k Ω	39 Ω to 221 k Ω	39 Ω to 511 k Ω	39 Ω to 1 M Ω			
\pm 10 ppm/K (9)	± 0.1 %	150 Ω to 130 k Ω	47 Ω to 221 kΩ	47 Ω to 511 kΩ	47 Ω to 1 M Ω			

Notes

⁽²⁾ Resistance values to be selected from E96 and E192 series, other values are available on request

⁽³⁾ TCR 10 is specified over the temperature range from - 10 °C to 85 °C

Resistance ranges printed in bold are preferred TCR/tolerance combinations with optimized availability.

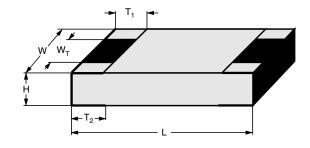
PACKAGING		
	REEL	
MODEL	PIECES/ PAPER TAPE ON REEL	CODE
MCS 0402	1000	E1
IVICS 0402	10 000	E0
	1000	P1
MCT 0603	5000	P5
	20 000	PW
	1000	P1
MCU 0805	5000	P5
	20 000	PW
MOA 1000	1000	P1
MCA 1206	5000	P5

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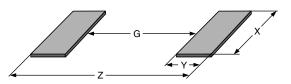


DIMENSIONS



DIMENSI	DIMENSIONS AND MASS										
ТҮРЕ	H (mm)	L (mm)	W (mm)	W _T (mm)	T ₁ (mm)	T ₂ (mm)	MASS (mg)				
MCS 0402	0.32 ± 0.05	1.0 ± 0.05	0.5 ± 0.05	> 75 % of W	0.2 + 0.1/- 0.15	0.2 ± 0.1	0.6				
MCT 0603	0.45 + 0.1/- 0.05	1.55 ± 0.05	0.85 ± 0.1	> 75 % of W	0.3 + 0.15/- 0.2	0.3 + 0.15/- 0.2	1.9				
MCU 0805	0.45 + 0.1/- 0.05	2.0 ± 0.1	1.25 ± 0.15	> 75 % of W	0.4 + 0.1/- 0.2	0.4 + 0.1/- 0.2	4.6				
MCA 1206	0.55 ± 0.1	3.2 + 0.1/- 0.2	1.6 ± 0.15	> 75 % of W	0.5 ± 0.25	0.5 ± 0.25	9.2				

SOLDER PAD DIMENSIONS



RECOMMENDED SOLDER PAD DIMENSIONS									
		WAVE SC	LDERING			REFLOW SOLDERING			
ТҮРЕ	G (mm)	Y (mm)	X (mm)	Z (mm)	G (mm)	Y (mm)	X (mm)	Z (mm)	
MCS 0402	-	-	-	-	0.35	0.55	0.55	1.45	
MCT 0603	0.55	1.10	1.10	2.75	0.65	0.70	0.95	2.05	
MCU 0805	0.80	1.25	1.50	3.30	0.90	0.90	1.40	2.70	
MCA 1206	1.40	1.50	1.90	4.40	1.50	1.15	1.75	3.80	

Note

• The given solder pad dimensions reflect the considerations for board design and assembly as outlined e.g. in standards IEC 61188-5-x, or in publication IPC-7351. They do not guarantee any supposed thermal properties, particularly as these are also strongly influenced by many other parameters.

Still, the given solder pad dimensions will be found adequate for most general applications, e.g. those referring to "standard operation mode".



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DESCRIPTION

Production is strictly controlled and follows an extensive set of instructions established for reproducibility. A homogeneous film of metal alloy is deposited on a high grade Al_2O_3 ceramic substrate and conditioned to achieve the desired temperature coefficient. Specially designed inner contacts are deposited on both sides. A special laser is used to achieve the target value by smoothly fine trimming the resistive layer without damaging the ceramics. A further conditioning is applied in order to stabilize the trimming result. The resistor elements are covered by a blue protective coating designed for electrical, mechanical and climatic protection. The terminations receive a final pure tin on nickel plating.

The result of the determined production is verified by an extensive testing procedure and optical inspection performed on 100 % of the individual chip resistors. Only accepted products are laid directly into the paper tape in accordance with **IEC 60286-3** ⁽³⁾.

ASSEMBLY

The resistors are suitable for processing on automatic SMD assembly systems and for automatic soldering using wave, reflow or vapour phase. The encapsulation is resistant to all cleaning solvents commonly used in the electronics industry, including alcohols, esters and aqueous solutions. The suitability of conformal coatings, if applied, shall be qualified by appropriate means to ensure the long-term stability of the whole system.

The resistors are RoHS compliant, the pure tin plating provides compatibility with lead (Pb)-free and lead-containing soldering processes. Solderability is specified for 2 years after production or requalification. The permitted storage time is 20 years. The immunity of the plating against tin whisker growth has been proven under extensive testing.

All products comply with the **GADSL**⁽¹⁾ and the **CEFIC-EECA-EICTA**⁽²⁾ list of legal restrictions on hazardous substances. This includes full compliance with the following directives:

- 2000/53/EC End of Vehicle life Directive (ELV) an Annex II (ELV II)
- 2002/95/EC Restriction of the use of Hazardous Substances Directive (RoHS)
- 2002/96/EC Waste Electrical and Electronic Equipment Directive (WEEE)

Notes

- ⁽¹⁾ Global Automotive Declarable Substance List, see <u>www.gadsl.org</u>
- (2) CEFIC (European Chemical Industry Council), EECA (European Electronic Component Manufacturers Association), EICTA (European trade organisation representing the information and communications technology and consumer electronics), see <u>www.eicta.org/index.php?id=995</u> → issues → environment policy → chemicals → chemicals for electronics
- ⁽³⁾ The quoted IEC standards are also released as EN standards with the same number and identical contents

APPOVALS

The resistors are approved within the IECQ-CECC Quality Assessment System for Electronic Components to the detail specification **EN 140401-801** which refers to **EN 60115-1**, **EN 140400** and the variety of environmental test procedures of the **IEC 60068** ⁽³⁾ series.

Conformity is attested by the use of the **CECC** Logo (**(**) as the Mark of Conformity on the package label.

Vishay BEYSCHLAG has achieved "Approval of Manufacturer" in accordance with IEC QC 001002-3, clause 2. The release certificate for "Technology Approval Schedule" in accordance with CECC 240001 based on IEC QC 001002-3, clause 6 is granted for the Vishay BEYSCHLAG manufacturing process.

RELATED PRODUCTS

On request, resistors are available with **established reliability** in accordance with **EN 140401-801** version E. Please refer to the special datasheet document no. **28744** for information on failure rate level, available resistance ranges and order codes.

For more information about products with higher rated power and higher operation temperature please refer to the **Professional Thin Film Chip Resistor** datasheet document no. **28705**.

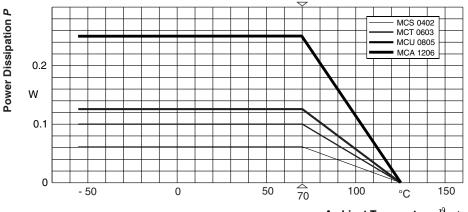
Precision **chip resistor arrays** may be used in voltage divider applications or precision amplifiers where close matching between multiple resistors is necessary. Please refer to the ACAS 0612 - Precision datasheet document no. **28751**.



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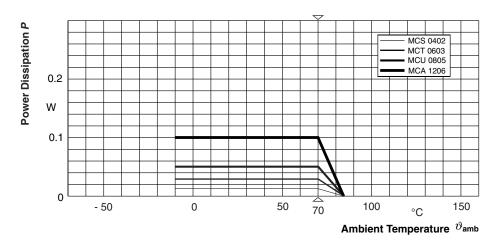
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FUNCTIONAL PERFORMANCE

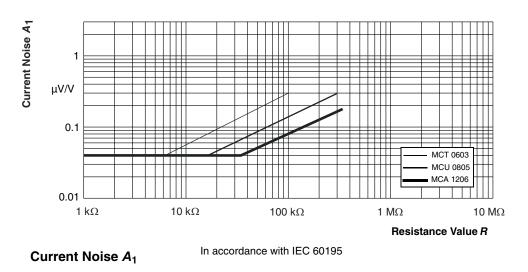


Ambient Temperature $\,artheta_{\mathsf{amb}}$











Precision Thin Film Chip Resistors

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TEST AND REQUIREMENTS

All tests are carried out in accordance with the following specifications:

EN 60115-1, generic specification (includes tests)

EN 140400, sectional specification (includes schedule for qualification approval)

EN 140401-801, detail specification (includes schedule for conformance inspection)

The components are approved in accordance with the European CECC-system, where applicable. The following table contains only the most important tests. For the full test schedule refer to the documents listed above. The testing also covers most of the requirements specified by EIA/IS-703 and JIS-C-5202.

The tests are carried out in accordance with IEC 60068 and under standard atmospheric conditions in accordance with

IEC 60068-1, 5.3. Climatic category LCT/UCT/56 (rated temperature range: Lower Category Temperature, Upper Category Temperature; damp heat, long term, 56 days) is valid. Unless otherwise specified the following values apply:

Temperature: 15 °C to 35 °C

Relative humidity: 45 % to 75 %

Air pressure: 86 kPa to 106 kPa (860 mbar to 1060 mbar).

The components are mounted for testing on boards in accordance with EN 60115-1, 4.31 unless otherwise specified.

The parameters stated in the Test Procedures and Requirements table are based on the required tests and permitted limits of EN 140401-801. However, some additional tests and a number of improvements against those minimum requirements have been included.

TEST P	ROCEDUR	RES AND RE	QUIREMENTS			
EN 60115-1	IEC 60068-2	TEST	PROCEDURE	REQUIR PERMISSIBLE		
CLAUSE	TEST METHOD	_		STABILITY CLASS 0.1	STABILITY CLASS 0.25	
			Stability for product types:			
			MCS 0402	470 Ω to 10 k Ω	> 10 k Ω to 52.3 k Ω	
			MCT 0603	100 Ω to 10 k Ω	39 Ω to < 100 Ω; > 10 kΩ to 511 kΩ	
			MCU 0805	100 Ω to 47.5 k Ω	39 Ω to < 100 Ω; > 47.5 kΩ to 1.5 MΩ	
			MCA 1206	47 Ω to 332 k Ω	39 Ω to < 47 Ω; > 332 kΩ to 2 MΩ	
4.5	-	Resistance		± 0.1 % <i>R</i> ; ± 0.25 % <i>R</i>		
4.8.4.2	-	Temperature coefficient	At (20/- 10/20) °C and (20/85/20) °C	± 25 ppm/K; ± 15 ppm/K; ± 10 ppm/K		
	-	Endurance at 70 °C: Precision	$U = \sqrt{P_{70} \times R} \text{ or } U = U_{\text{max.}};$ whichever is the less severe; 1.5 h on; 0.5 h off;			
		operation mode	70 °C; 1000 h	\pm (0.1 % R + 0.02 Ω) ⁽¹⁾		
4.25.1			70 °C; 8000 h	\pm (0.2 % R + 0.02 Ω) ⁽¹⁾		
	-	Endurance at 70 °C:	$U = \sqrt{P_{70} \times R} \text{ or } U = U_{\text{max.}};$ whichever is the less severe; 1.5 h on; 0.5 h off;			
		Standard operation mode	70 °C; 1000 h	± (0.2 % R	+ 0.02 Ω) ⁽¹⁾	
		oporation mode	70 °C; 8000 h	\pm (0.4 % R + 0.05 Ω) ⁽¹⁾		
4.25.3	-	Endurance at upper category temperature	85 °C; 1000 h 125 °C; 1000 h	$\pm (0.1 \% R + 0.02 \Omega)$ $\pm (0.2 \% R + 0.02 \Omega)$	\pm (0.2 % R + 0.02 Ω) \pm (0.25 % R + 0.05 Ω)	
4.24	78 (Cab)	Damp heat, steady state	(40 ± 2) °C; 56 days; (93 ± 3) % RH	\pm (0.1 % R + 0.02 Ω)	± (0.25 % <i>R</i> + 0.05 Ω)	

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TEST PROCEDURES AND REQUIREMENTS							
EN 60115-1	IEC 60068-2	TEST	PROCEDURE	REQUIRI PERMISSIBLE			
CLAUSE	TEST METHOD	_		STABILITY CLASS 0.1	STABILITY CLASS 0.25		
			Stability for product types:				
			MCS 0402	470 Ω to 10 k Ω	> 10 k Ω to 52.3 k Ω		
			MCT 0603	100 Ω to 10 $k\Omega$	39 Ω to < 100 Ω; > 10 kΩ to 511 kΩ		
			MCU 0805	100 Ω to 47.5 k Ω	39 Ω to < 100 Ω; > 47.5 kΩ to 1.5 MΩ		
			MCA 1206	47 Ω to 332 k Ω	39 Ω to < 47 Ω; > 332 kΩ to 2 MΩ		
4.23		Climatic sequence:					
4.23.2	2 (Ba)	dry heat	UCT; 16 h				
4.23.3	30 (Db)	damp heat, cyclic	55 °C; 24 h; > 90 % RH; 1 cycle				
4.23.4	1 (Aa)	cold	LCT; 2 h	$\pm (0.1 \% R + 0.02 \Omega)$	$\pm (0.25 \% R + 0.05 \Omega)$		
4.23.5	13 (M)	low air pressure	8.5 kPa; 2 h; (25 ± 10) °C				
4.23.6	30 (Db)	damp heat, cyclic	55 °C; 5 days; > 95 % to 100 % RH; 5 cycles LCT = - 55 °C; UCT = 125 °C				
-	1 (Aa)	Cold	- 55 °C; 2 h	± (0.05 % R + 0.01 Ω)			
4.19	14 (Na)	Rapid change of temperature	30 min at LCT and 30 min at UCT; LCT = - 10 °C UCT = 85 °C; 5 cycles	± (0.05 % <i>R</i> + 0.01 Ω) no visible damage			
			LCT = - 55 °C; UCT = 125 °C; 1000 cycles	\pm (0.25 % R + 0.05 Ω) no visible damage			
4.13	-	Short time overload; precision operation mode	$U = 2.5 \times \sqrt{P_{70} \times R}$ or $U = 2 \times U_{\text{max}};$	± (0.05 % <i>R</i> + 0.01 Ω)			
		Short time overload; standard operation mode	whichever is the less severe; 5 s	± (0.05 % F	R + 0.01 Ω)		
4.27	-	Single pulse high voltage overload; standard operation mode	Severity no. 4: $U = 10 \text{ x } \sqrt{P_{70} \text{ x } R}$ or $U = 2 \text{ x } U_{\text{max.}}$; whichever is the less severe; 10 pulses 10 µs/700 µs	± (0.5 % <i>R</i> + 0.05 Ω) ⁽²⁾ no visible damage			
4.37	-	Periodic electric overload; standard operation mode	$U = \sqrt{15 \times P_{70} \times R} \text{ or}$ $U = 2 \times U_{\text{max}};$ whichever is the less severe; 0.1 s on; 2.5 s off; 1000 cycles	\pm (0.5 % R + 0.05 Ω) ⁽²⁾ no visible damage			
4.22	6 (Fc)	Vibration	Endurance by sweeping; 10 Hz to 2000 Hz; no resonance; amplitude \leq 1.5 mm or \leq 200 m/s ² ; 6 h	± (0.05 % <i>R</i> + 0.01 Ω) no visible damage			



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EN 60115-1	IEC 60068-2		PROCEDURE	REQUIREMENTS PERMISSIBLE CHANGE (<i>\\Lambda R</i>)			
CLAUSE METHOD			STABILITY CLASS 0.1	STABILITY CLASS 0.25			
			Stability for product types:				
			MCS 0402	470 Ω to 10 k Ω	> 10 k Ω to 52.3 k Ω		
			MCT 0603	100 Ω to 10 k Ω	39 Ω to < 100 Ω; > 10 kΩ to 511 kΩ		
			MCU 0805	100 Ω to 47.5 k Ω	39 Ω to < 100 Ω; > 47.5 kΩ to 1.5 MΩ		
			MCA 1206	47 Ω to 332 k Ω	39 Ω to < 47 Ω; > 332 kΩ to 2 MΩ		
			Solder bath method; SnPb40; non-activated flux (215 ± 3) °C; (3 ± 0.3) s	Cood tinning (OF % covered);		
4.17.2	58 (Td)	Solderability	Solder bath method; SnAg3Cu0.5 or SnAg3.5; non-activated flux (235 ± 3) °C; (2 ± 0.2) s	Good tinning (≥ 95 % covered); no visible damage			
4.18.2	58 (Td)	Resistance to soldering heat	Solder bath method; (260 \pm 5) °C; (10 \pm 1) s	± (0.05 % <i>R</i> + 0.01 Ω)			
4.29	45 (XA)	Component solvent resistance	Isopropyl alcohol + 50 °C; method 2	No visible damage			
1.00	01 (11-)	Shear	RR 1005M and RR 1608M; 9 N				
4.32	21 (Ue ₃)	(adhesion)	RR 2012M and RR 3216M; 45 N		e damage		
4.33	21 (Ue ₁)	Substrate bending	Depth 2 mm, 3 times	•	$R + 0.01 \Omega$) ben circuit in bent position		
4.7	-	Voltage proof	$U_{\rm RMS} = U_{\rm ins}; (60 \pm 5) {\rm s}$	No flashover	or breakdown		
4.35	-	Flammability	IEC 60695-2-2, needle flame test; 10 s	No burning after 30 s			
Special requ	uirements for t	ype MCA 1206					
		Endurance at 70 °C:	$U = \sqrt{P_{70} \times R}$ or $U = U_{max.}$; whichever is the less severe;				
	-	Precision	70 °C; 1000 h	± (0.05 %	R + 0.02 Ω)		
1 05 1		operation mode	70 °C; 8000 h	\pm (0.1 % R + 0.02 Ω)			
4.25.1		Endurance at 70 °C:	$U = \sqrt{P_{70} \times R}$ or $U = U_{max}$; whichever is the less severe;				
	-	Standard	70 °C; 1000 h	± (0.1 % <i>H</i>	R + 0.02 Ω)		
		operation mode	70 °C; 8000 h	± (0.25 % <i>R</i> + 0.05 Ω)			

Notes

⁽¹⁾ See 4.25.1 (above): special requirements for type MCA 1206

(2) The pulse load stability of professional MFC resistors applies for precision resistors also. However, severe pulse loads are likely to jeopardise precision stability requirements.

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Precision Thin Film Chip Resistors



12NC INFORMATION FOR HISTORICAL CODING REFERENCE ONLY

- The resistors have a 12-digit numeric code starting with 2312.
- The subsequent 4 digits indicate the resistor type, specification and packaging; see the 12NC table.
- The remaining 4 digits indicate the resistance value:
 - The first 3 digits indicate the resistance value.
 - The last digit indicates the resistance decade in accordance with the 12NC Indicating Resistance Decade table.

Last Digit of 12NC Indicating Resistance Decade

RESISTANCE DECADE	LAST DIGIT
10 Ω to 99.9 Ω	9
100 Ω to 999 Ω	1
1 kΩ to 9.99 kΩ	2
10 kΩ to 99.9 kΩ	3
100 kΩ to 999 kΩ	4
1 MΩ to 9.99 MΩ	5

12NC Example

The 12NC of a MCT 0603 resistor, value 47 k Ω and TCR 25 with \pm 0.1 % tolerance, supplied in cardboard tape of 5000 units per reel is: 2312 216 74703.

12NC - Re	sistors type an	d packaging	1						
	DESCRIPTION		CODE 2312						
DESCRIPTION				CARDBOARD TAPE ON REEL					
ТҮРЕ	TCR	TOL.	P1 1000 UNITS	P5 5000 UNITS	PW 20 000 UNITS	E1 1000 UNITS	E0 10 000 UNITS		
	± 25 ppm/K	± 0.25 %	-	-	-	261 6	276 6		
	± 25 ppm/K	± 0.1 %	-	-	-	261 7	276 7		
MCS 0402	± 15 ppm/K	± 0.25 %	-	-	-	262 6	277 6		
1003 0402	± 15 ppm/K	± 0.1 %	-	-	-	262 7	277 7		
	± 10 ppm/K	± 0.25 %	-	-	-	263 6	278 6		
	± 10 ppm/K	± 0.1 %	-	-	-	263 7	278 7		
	± 25 ppm/K	± 0.25 %	201 6	216 6	206 6	-	-		
		± 0.1 %	201 7	216 7	206 7	-	-		
MCT 0603	± 15 ppm/K	± 0.25 %	202 6	217 6	207 6	-	-		
MC1 0003		± 0.1 %	202 7	217 7	207 7	-	-		
	± 10 ppm/K	± 0.25 %	203 6	218 6	208 6	-	-		
		± 0.1 %	203 7	218 7	208 7	-	-		
	± 25 ppm/K	± 0.25 %	241 6	256 6	246 6	-	-		
		± 0.1 %	241 7	256 7	246 7	-	-		
MCU 0805	± 15 ppm/K	± 0.25 %	242 6	257 6	247 6	-	-		
WC0 0805	± 15 ppm/K	± 0.1 %	242 7	257 7	247 7	-	-		
	± 10 ppm/K	± 0.25 %	243 6	258 6	248 6	-	-		
		± 0.1 %	243 7	258 7	248 7	-	-		
	± 25 ppm/K	± 0.25 %	381 6	396 6	386 6	-	-		
	± 25 ppm/K	± 0.1 %	381 7	396 7	386 7	-	-		
MCA 1206	± 15 ppm/K	± 0.25 %	382 6	397 6	387 6	-	-		
MOA 1200	± 15 ppm/K	± 0.1 %	382 7	397 7	387 7	-	-		
	± 10 ppm/K	± 0.25 %	383 6	398 6	388 6	-	-		
		± 0.1 %	383 7	398 7	388 7	-	-		



Vishay

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